



May 2014

FAN48610 2.5 MHz, Fixed-Output Synchronous TinyBoost® Regulator

Features

- Input Voltage Range: 2.35 V to 5.50 V
- Output Voltages Range: 3.0 V to 5.0 V
- $I_{OUT} \geq 1$ A at $V_{OUT} = 5.0$ V, $V_{IN} \geq 2.5$ V
- $I_{OUT} \geq 1.5$ A at $V_{OUT} = 5.0$ V, $V_{IN} \geq 3.0$ V
- Up to 94% Efficient
- Automatic Pass-Through Operation when $V_{IN} > V_{OUT}$
- Internal Synchronous Rectification
- Soft-Start with True Load Disconnect
- Short-Circuit Protection
- 9-Bump, 1.215 mm x 1.215 mm, 0.4 mm Pitch WLCSP
- Three External Components: 2016 0.47 μ H Inductor, 0603 Case Size Input / Output Capacitors
- Total Application Board Solution Size: < 11 mm²

Applications

- Class-D Audio Amplifier and USB OTG Supply
- Boost for Low-Voltage Li-Ion Batteries
- Smart Phones, Tablets, Portable Devices

Description

The FAN48610 is a low-power boost regulator designed to provide a minimum voltage-regulated rail from a standard single-cell Li-Ion battery and advanced battery chemistries. Even below the minimum system battery voltage, the device maintains the output voltage regulation for a minimum output load current of 1.0 A. The combination of built-in power transistors, synchronous rectification, and low supply current suit the FAN48610 for battery-powered applications.

The FAN48610 is available in a 9-bump, 0.4 mm pitch, Wafer-Level Chip-Scale Package (WLCSP).

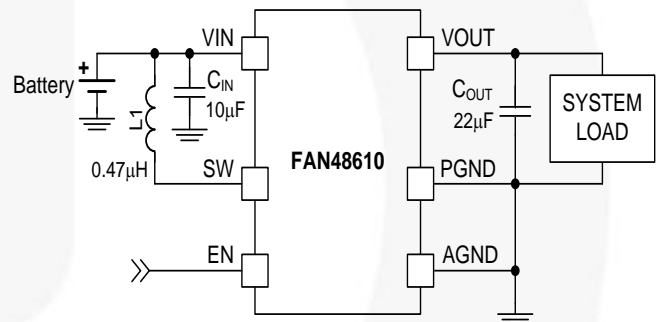


Figure 1. Typical Application

Ordering Information

Part Number	V _{OUT}	Operating Temp	Package	Packing ⁽¹⁾
FAN48610UC50X	5.0 V	-40°C to 85°C	WLCSP, 0.4 mm Pitch	Tape and Reel
FAN48610BUC50X ⁽²⁾	5.0 V	-40°C to 85°C	WLCSP, 0.4 mm Pitch	Tape and Reel

Notes:

1. Please refer to Application Note AN-6054 — *Tape and Reel Specifications* on www.fairchildsemi.com.
2. The FAN48610BUC50X includes backside lamination.

Block Diagrams

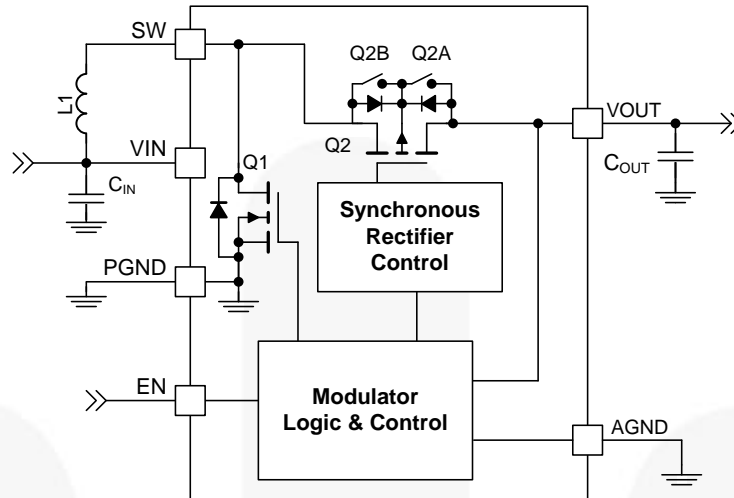


Figure 2. IC Block Diagram

Table 1. Recommended Components

Component	Description	Vendor	Parameter	Typ.	Unit
L1	0.47 μ H, 30%, 2016	Toko: DFE201612C DFR201612C Cynotec: PIFE20161B	L	0.47	μ H
			DCR (Series R)	40	m Ω
C _{IN}	10 μ F, 10%, 6.3 V, X5R, 0603	Murata: GRM188R60J106K TDK: C1608X5R0J106K	C	10	μ F
C _{OUT}	22 μ F, 20%, 6.3 V, X5R, 0603	TDK: C1608X5R0J226M	C	22	μ F

Pin Configuration

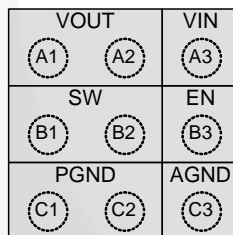


Figure 3. Top View

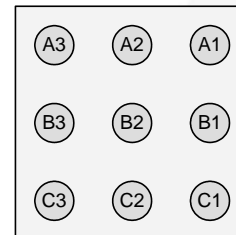


Figure 4. Bottom View

Pin Definitions

Pin #	Name	Description
A1, A2	VOUT	Output Voltage. This pin is the output voltage terminal; connect directly to C _{OUT} .
A3	VIN	Input Voltage. Connect to Li-Ion battery input power source and the bias supply for the gate drivers.
B1, B2	SW	Switching Node. Connect to inductor.
B3	EN	Enable. When this pin is HIGH, the circuit is enabled. ⁽³⁾
C1, C2	PGND	Power Ground. This is the power return for the IC. C _{OUT} capacitor should be returned with the shortest path possible to these pins.
C3	AGND	Analog Ground. This is the signal ground reference for the IC. All voltage levels are measured with respect to this pin – connect to PGND at a single point.

Note:

3. The EN pin can be connected to VIN, but should be driven by a logic voltage of 1.8 V to enable / disable the device.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
V_{IN}	Voltage on VIN Pin		-0.3	6.0	V
V_{OUT}	Voltage on VOUT Pin			6.0	V
SW	SW Node	DC	-0.3	6.0	V
		Transient: 10 ns, 3 MHz	-1.0	8.0	
	Voltage on Other Pins		-0.3	6.0 ⁽⁴⁾	V
ESD	Electrostatic Discharge Protection Level	Human Body Model per JESD22-A114	5		kV
		Charged Device Model per JESD22-C101	2		
T_J	Junction Temperature		-40	+150	°C
T_{STG}	Storage Temperature		-65	+150	°C
T_L	Lead Soldering Temperature, 10 Seconds			+260	°C

Note:

4. Lesser of 6.0 V or $V_{IN} + 0.3$ V.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Min.	Max.	Unit
V_{IN}	Supply Voltage	2.5	4.5	V
I_{OUT}	Maximum Output Current	1000		mA
T_A	Ambient Temperature	-40	+85	°C
T_J	Junction Temperature	-40	+125	°C

Thermal Properties

Junction-to-ambient thermal resistance is a function of application and board layout. This data is measured with four-layer 2s2p boards with vias in accordance to JEDEC standard JESD51. Special attention must be paid not to exceed junction temperature, $T_{J(max)}$, at a given ambient temperature, T_A .

Symbol	Parameter	Typical	Unit
Θ_{JA}	Junction-to-Ambient Thermal Resistance	50	°C/W

Electrical Specifications

Recommended operating conditions, unless otherwise noted, circuit per Figure 1, $V_{OUT} = 3.0\text{ V to }5.0\text{ V}$, $V_{IN} = 2.5\text{ V to }4.5\text{ V}$, $T_A = -40^\circ\text{C to }85^\circ\text{C}$. Typical values are given $V_{IN} = 3.6\text{ V}$ and $T_A = 25^\circ\text{C}$.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Units
Power Supply						
I_Q	V_{IN} Quiescent Current	$V_{IN}=3.6\text{ V}$, $I_{OUT}=0$, $EN=V_{IN}$		85	125	μA
		Shutdown: $EN=0$, $V_{IN}=3.6\text{ V}$		3	10	
V_{UVLO}	Under-Voltage Lockout	V_{IN} Rising		2.2	2.3	V
V_{UVLO_HYS}	Under-Voltage Lockout Hysteresis			150		mV
Inputs						
V_{IH}	Enable HIGH Voltage		1.05			V
V_{IL}	Enable LOW Voltage				0.4	V
I_{PD}	Current Sink Pull-Down	EN Pin, Logic HIGH		100		nA
R_{LOW}	Low-State Active Pull-Down	EN Pin, Logic LOW	200	300	400	k Ω
Outputs						
V_{REG}	Output Voltage Accuracy DC ⁽⁵⁾	Referred to V_{OUT}	-2		4	%
I_{LK_OUT}	V_{IN} -to- V_{OUT} Leakage Current	$V_{OUT}=0$, $EN=0$, $V_{IN}=4.2\text{ V}$			1	μA
I_{LK}	V_{OUT} -to- V_{IN} Reverse Leakage Current	$V_{OUT}=5.0\text{ V}$, $EN=0$, $V_{IN}=2.5\text{ V}$			3.5	μA
V_{TRSP}	Output Voltage Accuracy Transient ⁽⁶⁾	Referred to V_{OUT} , 50-500 mA Load Step	-5		5	%
Timing						
f_{SW}	Switching Frequency	$V_{IN}=3.6\text{ V}$, $V_{OUT}=5.0\text{ V}$, Load=1000 mA	2.0	2.5	3.0	MHz
t_{SS}	Soft-Start EN HIGH to Regulation	50 Ω Load, $V_{OUT} = 5.0\text{ V}$		600		μs
t_{RST}	FAULT Restart Timer			20		ms
Power Stage						
$R_{DS(ON)N}$	N-Channel Boost Switch $R_{DS(ON)}$	$V_{IN}=3.6\text{ V}$, $V_{OUT}=5.0\text{ V}$		80	130	m Ω
$R_{DS(ON)P}$	P-Channel Sync. Rectifier $R_{DS(ON)}$	$V_{IN}=3.6\text{ V}$, $V_{OUT}=5.0\text{ V}$		65	115	m Ω
I_{V_LIM}	Boost Valley Current Limit	$V_{OUT}=5.0\text{ V}$		3.0		A
$I_{V_LIM_SS}$	Boost Soft-Start Valley Current Limit	$V_{IN}<V_{OUT}<V_{OUT_TARGET}$, SS Mode		1.7		A
V_{OCP}	OCP Comparator Threshold	$V_{IN}=5.0\text{ V}$, $V_{IN}-V_{OUT}$		300		mV
$V_{MIN_1.0A}$	Minimum V_{IN} for 1000 mA Load	$V_{OUT}=5.0\text{ V}$		2.5		V
$V_{MIN_1.5A}$	Minimum V_{IN} for 1500 mA Load	$V_{OUT}=5.0\text{ V}$		3.0		V
T_{150T}	Over-Temperature Protection (OTP)			150		$^\circ\text{C}$
T_{150H}	OTP Hysteresis			20		$^\circ\text{C}$

Notes:

- DC I_{LOAD} from 0 to 1 A. V_{OUT} measured from mid-point of output voltage ripple. Effective capacitance of $C_{OUT} \geq 3\text{ }\mu\text{F}$.
- Guaranteed by design and characterization; not tested in production.

Typical Characteristics

Unless otherwise specified; $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.

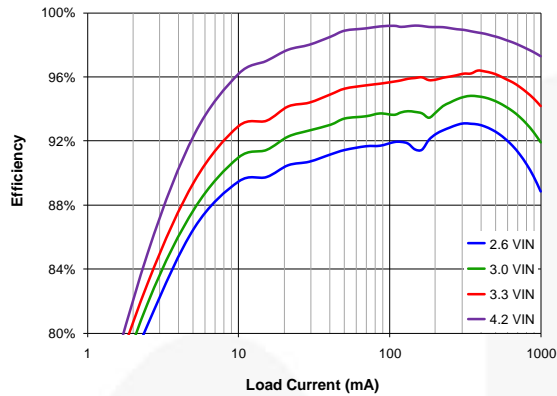


Figure 5. Efficiency vs. Load Current and Input Voltage, $V_{OUT}=3.5\text{ V}$

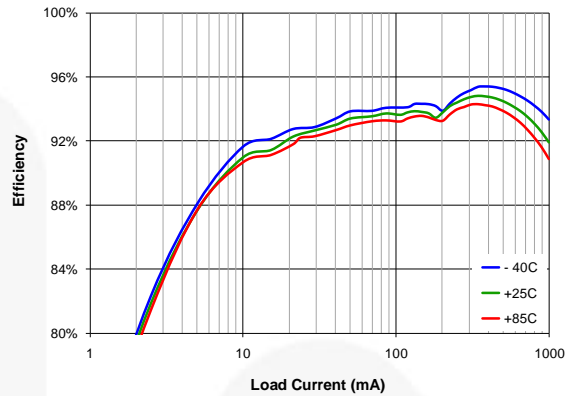


Figure 6. Efficiency vs. Load Current and Temperature, $V_{IN}=3.0\text{ V}$, $V_{OUT}=3.5\text{ V}$

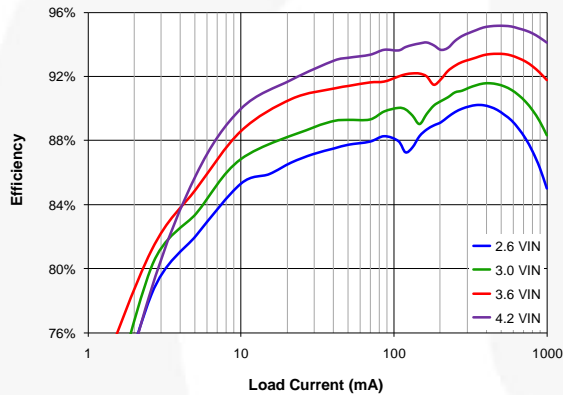


Figure 7. Efficiency vs. Load Current and Input Voltage

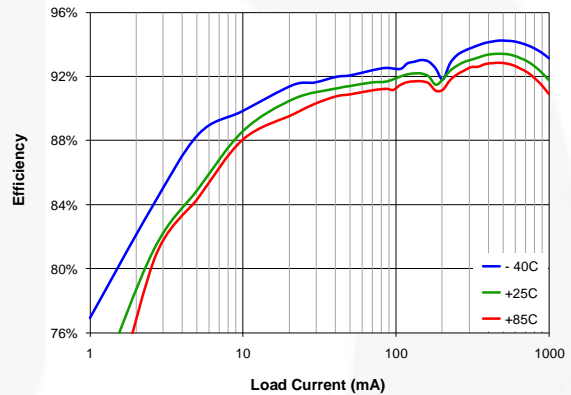


Figure 8. Efficiency vs. Load Current and Temperature

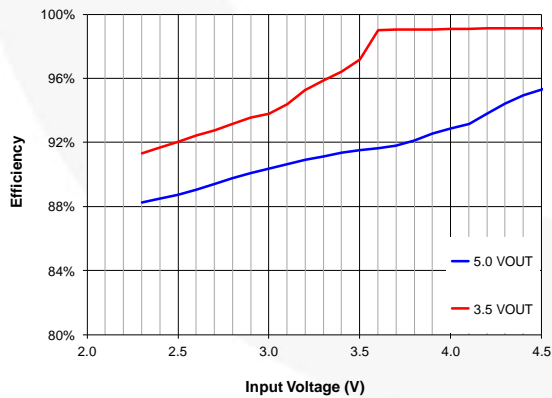


Figure 9. Efficiency vs. Input Voltage and Output Voltage, 200 mA Load

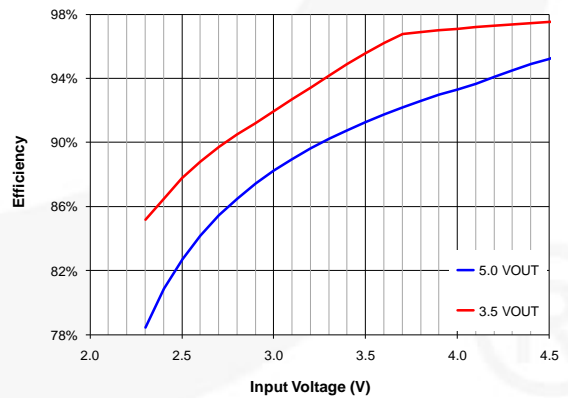


Figure 10. Efficiency vs. Input Voltage and Output Voltage, 1000 mA Load

Typical Characteristics

Unless otherwise specified; $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.

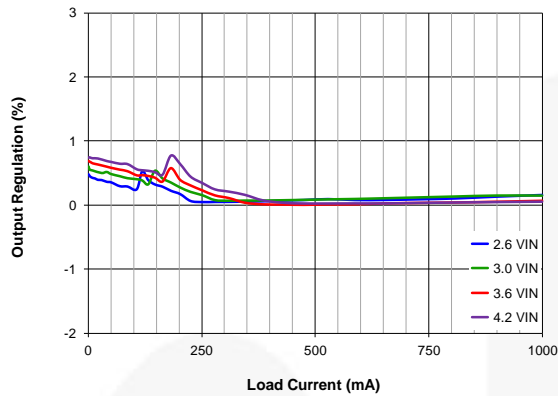


Figure 11. Output Regulation vs. Load Current and Input Voltage (Normalized to 3.6 V_{IN} , 500 mA Load)

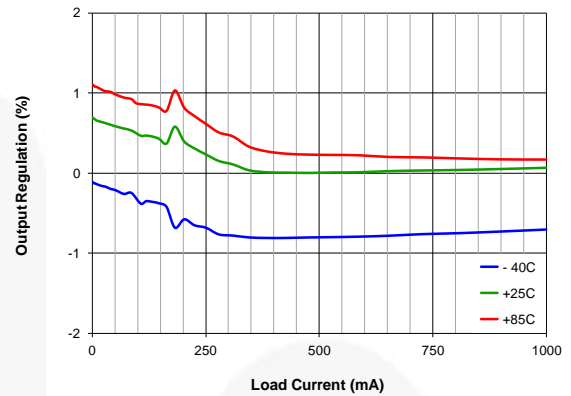


Figure 12. Output Regulation vs. Load Current and Temperature (Normalized to 3.6 V_{IN} , 500 mA Load, $T_A=25^\circ\text{C}$)

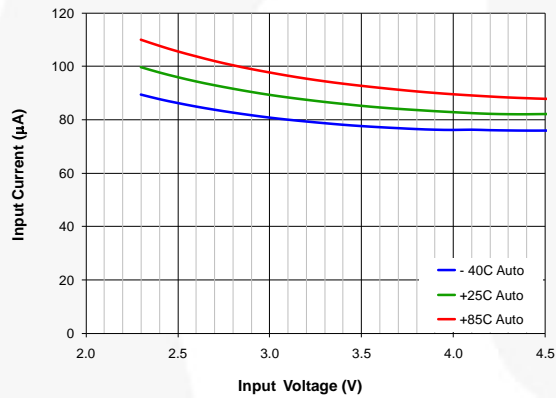


Figure 13. Quiescent Current vs. Input Voltage, Temperature, $V_{OUT}=5.0\text{ V}$

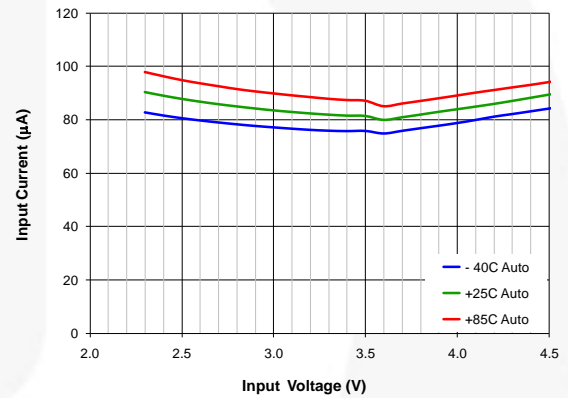


Figure 14. Quiescent Current vs. Input Voltage, Temperature, $V_{OUT}=3.5\text{ V}$

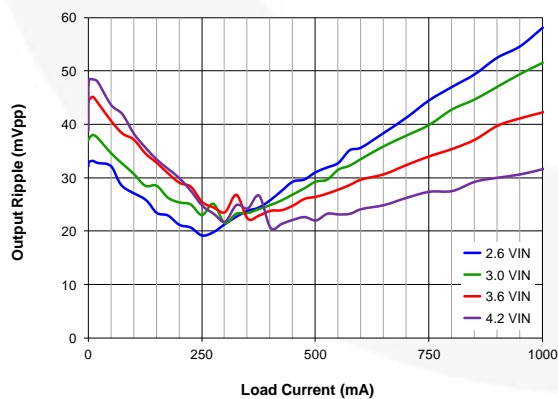


Figure 15. Output Ripple vs. Load Current and Input Voltage

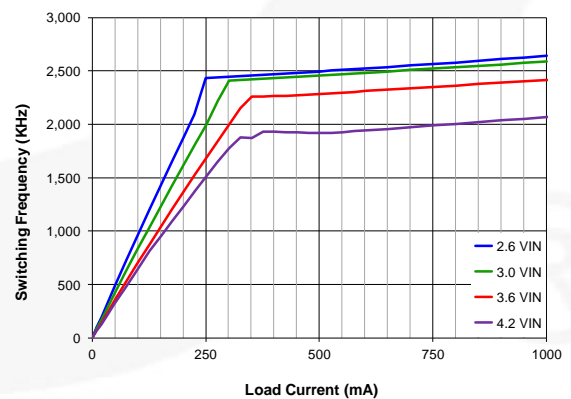


Figure 16. Frequency vs. Load Current and Input Voltage

Typical Characteristics

Unless otherwise specified; $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.

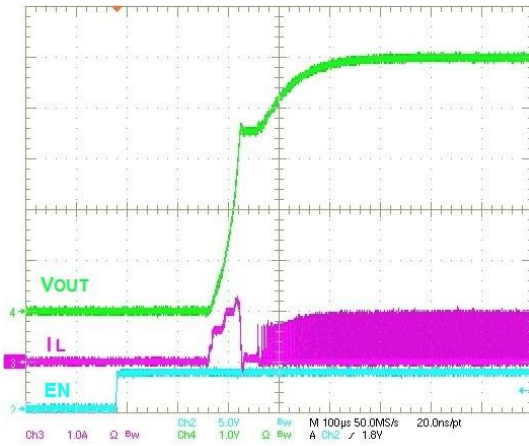


Figure 17. Startup, 50 Ω Load

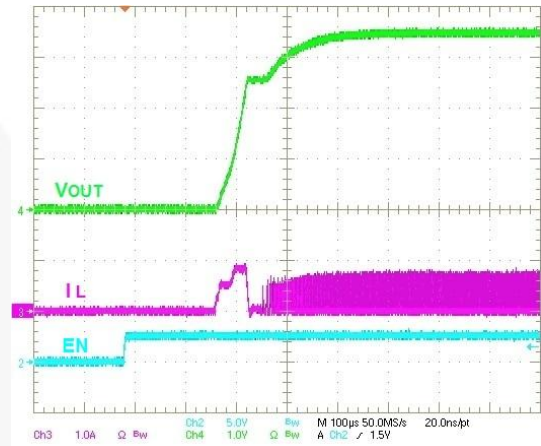


Figure 18. Startup, 50 Ω Load, $V_{IN} = 2.6\text{ V}$, $V_{OUT} = 3.5\text{ V}$

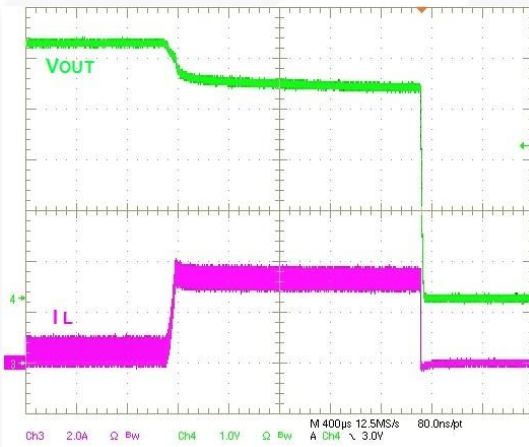


Figure 19. Overload Protection

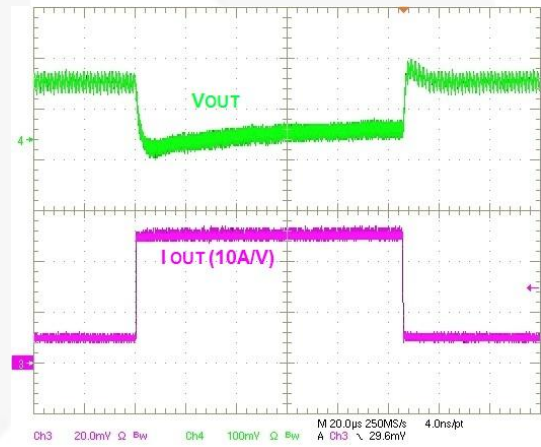


Figure 20. Load Transient, 100-500 mA, 100 ns Edge

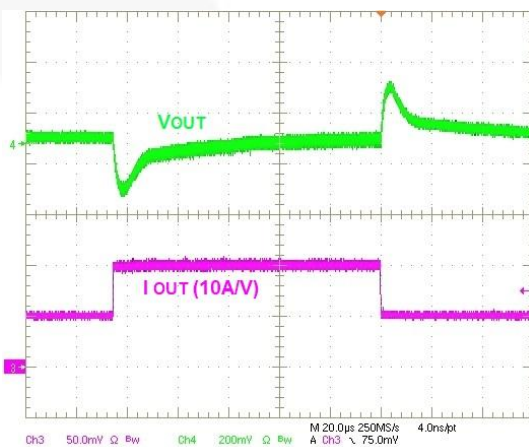


Figure 21. Load Transient, 500-1000 mA, 100 ns Edge

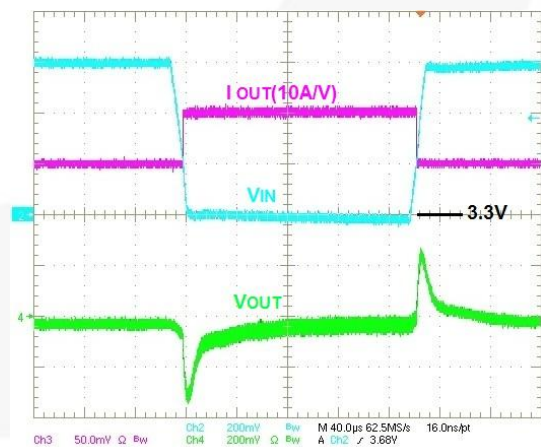


Figure 22. Simultaneous Line / Load Transient, 3.3-3.9 V_{IN} , 10 μs Edge, 500-1000 mA Load, 100 ns Edge

Typical Characteristics

Unless otherwise specified; $V_{IN} = 3.6\text{ V}$, $V_{OUT} = 5.0\text{ V}$, $T_A = 25^\circ\text{C}$, and circuit and components according to Figure 1.

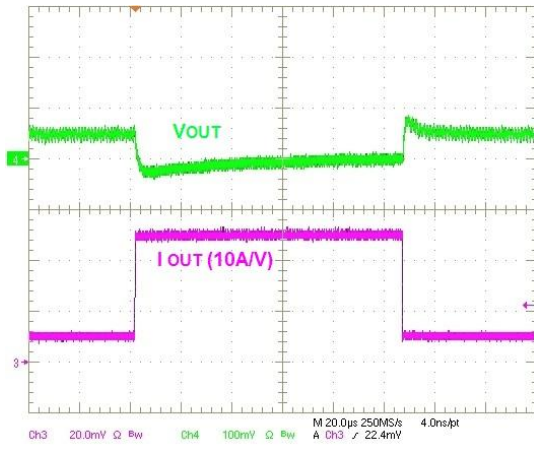


Figure 23. Load Transient, 100-500 mA, 100 ns Edge, $V_{IN}=3\text{ V}$, $V_{OUT}=3.5\text{ V}$

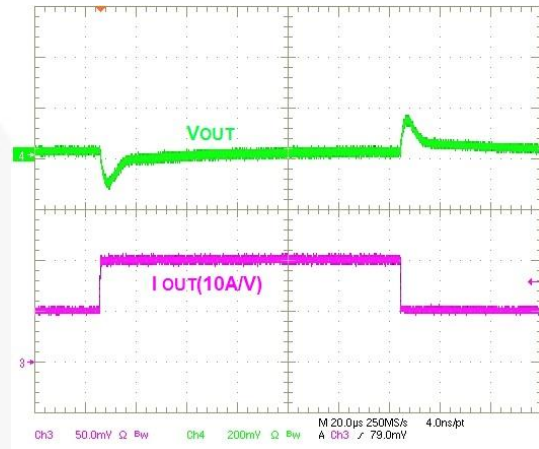


Figure 24. Load Transient, 500-1000 mA, 100 ns Edge, $V_{IN}=3\text{ V}$, $V_{OUT}=3.5\text{ V}$

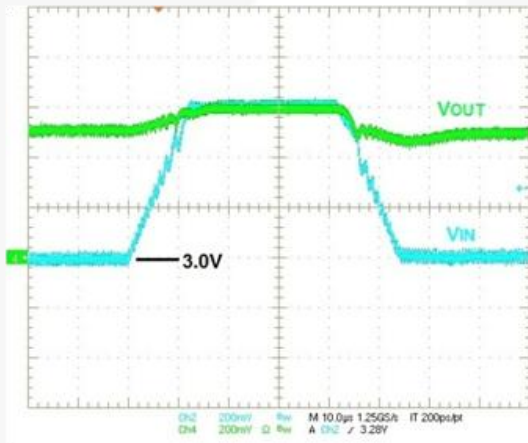


Figure 25. Line Transient, 3.0-3.6 V_{IN} , 10 μs Edge, 500 mA Load, $V_{OUT}=3.5\text{ V}$

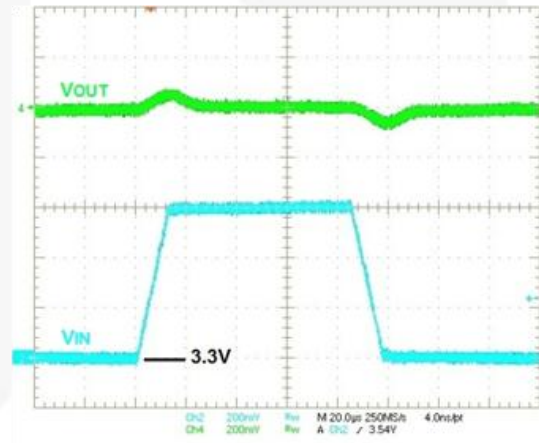


Figure 26. Line Transient, 3.3-3.9 V_{IN} , 10 μs Edge, 500 mA Load, $V_{OUT}=5.0\text{ V}$

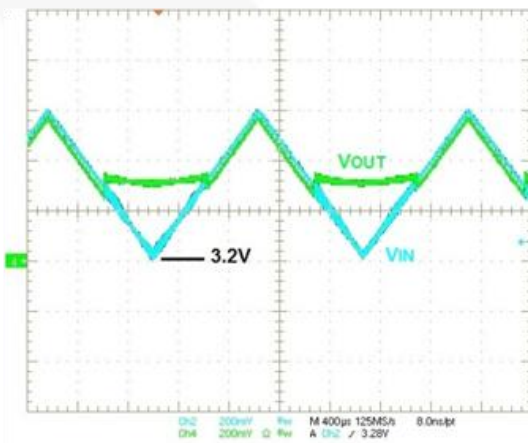


Figure 27. Pass-Through Entry / Exit, 3.2-3.8 V_{IN} , 1 ms Ramp, 500 mA Load, $V_{OUT}=3.5\text{ V}$

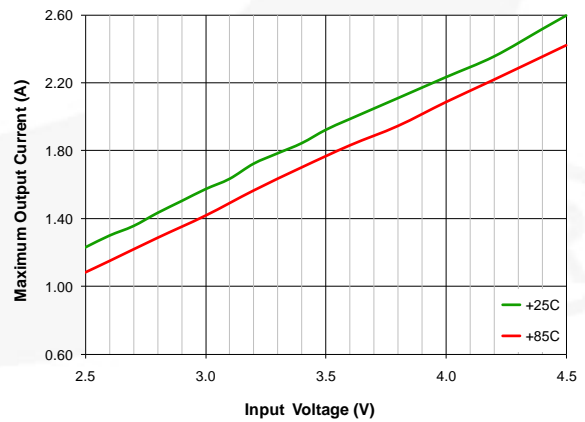


Figure 28. Typical Maximum Output Current vs. Input Voltage

Circuit Description

FAN48610 is a synchronous boost regulator, typically operating at 2.5 MHz in Continuous Conduction Mode (CCM), which occurs at moderate to heavy load current and low V_{IN} voltages. The regulator's Pass-Through Mode automatically activates when V_{IN} is above the boost regulator's set point.

Table 2. Operating Modes

Mode	Description	Invoked When:
LIN	Linear Startup	$V_{IN} > V_{OUT}$
SS	Boost Soft-Start	$V_{IN} < V_{OUT} < V_{OUT(TARGET)}$
BST	Boost Operating Mode	$V_{OUT} = V_{OUT(TARGET)}$
PT	Pass-Through Mode	$V_{IN} > V_{OUT(TARGET)}$

Boost Mode Regulation

The FAN48610 uses a current-mode modulator to achieve excellent transient response and smooth transitions between CCM and DCM operation. During CCM operation, the device maintains a switching frequency of about 2.5 MHz. In light-load operation (DCM), frequency is naturally reduced to maintain high efficiency.

Shutdown and Startup

When EN is LOW, all bias circuits are off and the regulator is in Shutdown Mode. During shutdown, current flow is prevented from VIN to VOUT, as well as reverse flow from VOUT to VIN. It is recommended to keep load current draw below 500 mA until the devices successfully executes startup. The following table describes the startup sequence.

Table 3. Boost Startup Sequence

Start Mode	Entry	Exit	End Mode	Timeout (μs)
LIN1	$V_{IN} > V_{UVLO}$, EN=1	$V_{OUT} > V_{IN} - 300$ mV	SS	
		TIMEOUT	LIN2	512
LIN2	LIN1 Exit	$V_{OUT} > V_{IN} - 300$ mV	SS	
		TIMEOUT	FAULT	1024
SS	LIN1 or LIN2 Exit	$V_{OUT} = V_{OUT(TARGET)}$	BST	
		OVERLOAD TIMEOUT	FAULT	64

LIN Mode

When EN is HIGH and $V_{IN} > V_{UVLO}$, the regulator first attempts to bring V_{OUT} within 300 mV of V_{IN} by using the internal fixed-current source from VIN (Q2). The current is limited to the LIN1 set point.

If V_{OUT} reaches $V_{IN} - 300$ mV during LIN1 Mode, the SS Mode is initiated. Otherwise, LIN1 times out after 512 μs and LIN2 Mode is entered.

In LIN2 Mode, the current source is incremented to 1.6 A. If V_{OUT} fails to reach $V_{IN} - 300$ mV after 1024 μs, a fault condition is declared and the device waits 20 ms to attempt an automatic restart.

Soft-Start (SS) Mode

Upon the successful completion of LIN Mode ($V_{OUT} \geq V_{IN} - 300$ mV), the regulator begins switching with boost pulses current limited to 50% of nominal level.

During SS Mode, if V_{OUT} fails to reach regulation during the SS ramp sequence for more than 64 μs, a fault is declared. If large C_{OUT} is used, the reference is automatically stepped slower to avoid excessive input current draw.

Boost (BST) Mode

This is a normal operating mode of the regulator.

Pass-Through (PT) Mode

In normal operation, the device automatically transitions from Boost Mode to Pass-Through Mode if V_{IN} goes above the target V_{OUT} . In Pass-Through Mode, the device fully enhances Q2 to provide a very low impedance path from VIN to VOUT. Entry to the Pass-Through Mode is triggered by condition where $V_{IN} > V_{OUT}$ and no switching has occurred during the past 5 μs. To soften the entry into Pass-Through Mode, Q2 is driven as a linear current source for the first 5 μs. Pass-Through Mode exit is triggered when V_{OUT} reaches the target V_{OUT} voltage. During Automatic Pass-Through Mode, the device is short-circuit protected by a voltage comparator tracking the voltage drop from V_{IN} to V_{OUT} ; if the drop exceeds 300 mV, a fault is declared.

Fault State

The regulator enters Fault State under any of the following conditions:

- V_{OUT} fails to achieve the voltage required to advance from LIN Mode to SS Mode.
- V_{OUT} fails to achieve the voltage required to advance from SS Mode to BST Mode.
- Boost current limit triggers for 2 ms during BST Mode.
- $V_{IN} - V_{OUT} > 300$ mV; this fault can occur only after successful completion of the soft-start sequence.
- $V_{IN} < V_{UVLO}$.

Once a fault is triggered, the regulator stops switching and presents a high-impedance path between VIN and VOUT. After waiting 20 ms, an automatic restart is attempted.

Over-Temperature

The regulator shuts down if the die temperature exceeds 150°C. Restart occurs when the IC has cooled by approximately 20°C.

Application Information

Output Capacitance (C_{OUT})

The effective capacitance (C_{EFF}⁽⁷⁾) of small, high-value ceramic capacitors decreases as their bias voltage increases, as illustrated in the graph below:

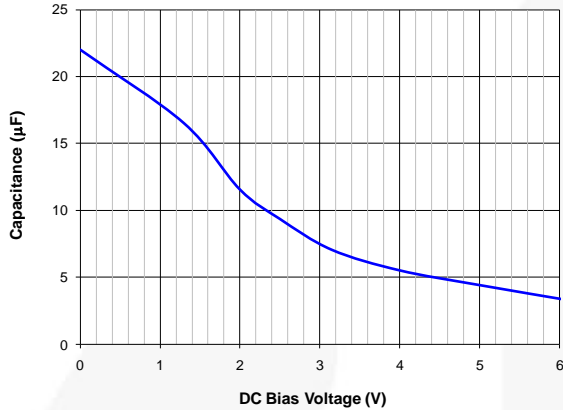


Figure 29. C_{EFF} for 22 µF, 0603, X5R, 6.3 V-Rated Capacitor (TDK C1608X5R0J226M)

FAN48610 is guaranteed for stable operation with the minimum value of C_{EFF} (C_{EFF(MIN)}) outlined in Table 4.

Table 4. Minimum C_{EFF} Required for Stability

Operating Conditions			C _{EFF(MIN)} (µF)
V _{OUT} (V)	V _{IN} (V)	I _{LOAD} (mA)	
5.0	2.5 to 4.5	0 to 1000	3.0

Note:

- C_{EFF} varies by manufacturer, capacitor material, and case size.

Inductor Selection

Recommended nominal inductance value is 0.47 µH.

The FAN48610 employs valley-current limiting, so peak inductor current can reach 3.8 A for a short duration during overload conditions. Saturation effects cause the inductor current ripple to become higher under high loading, as only the valley of the inductor current ripple is controlled.

Startup

Input current limiting is in effect during soft-start, which limits the current available to charge C_{OUT} and any additional capacitance on the V_{OUT} line. If the output fails to achieve regulation within the limits described in the Soft-Start section above, a fault occurs, causing the circuit to shut down. It waits about 20 ms before attempting a restart. If the total combined output capacitance is very high, the circuit may not start on the first attempt, but eventually achieves regulation if no load is present. If a high current load and high capacitance are both present during soft-start, the circuit may fail to achieve regulation and continually attempt soft-start, only to have the output capacitance discharged by the load when in Fault State.

Output Voltage Ripple

Output voltage ripple is inversely proportional to C_{OUT}. During t_{ON}, when the boost switch is on, all load current is supplied by C_{OUT}.

$$V_{RIPPLE(P-P)} = t_{ON} \cdot \frac{I_{LOAD}}{C_{OUT}} \quad \text{EQ. 1}$$

and

$$t_{ON} = t_{SW} \cdot D = t_{SW} \cdot \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \quad \text{EQ. 2}$$

therefore:

$$V_{RIPPLE(P-P)} = t_{SW} \cdot \left(1 - \frac{V_{IN}}{V_{OUT}}\right) \cdot \frac{I_{LOAD}}{C_{OUT}} \quad \text{EQ. 3}$$

$$t_{SW} = \frac{1}{f_{SW}} \quad \text{EQ. 4}$$

The maximum V_{RIPPLE} occurs when V_{IN} is minimum and I_{LOAD} is maximum. For better ripple performance, more output capacitance can be added.

Layout Recommendations

The layout recommendations below highlight various top-copper pours by using different colors.

To minimize spikes at V_{OUT}, C_{OUT} must be placed as close as possible to PGND and V_{OUT}, as shown below.

For thermal reasons, it is suggested to maximize the pour area for all planes other than SW. Especially the ground pour should be set to fill all available PCB surface area and tied to internal layers with a cluster of thermal vias.

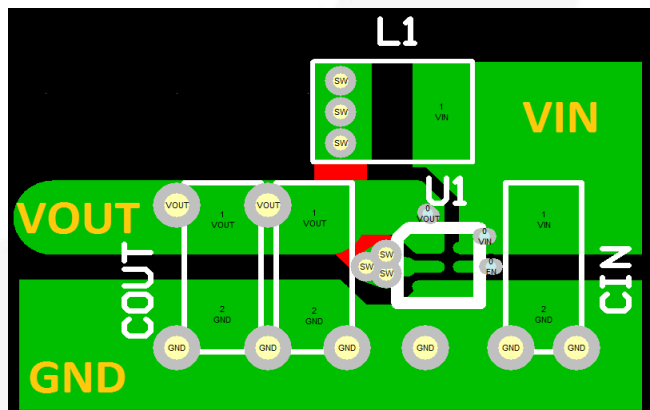
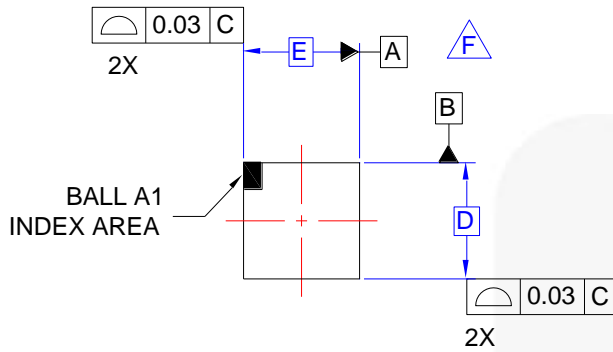
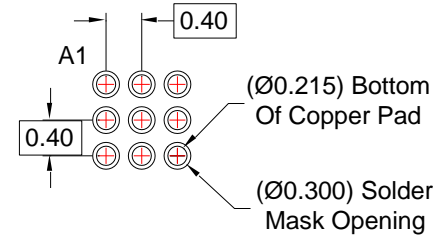


Figure 30. Layout Recommendation

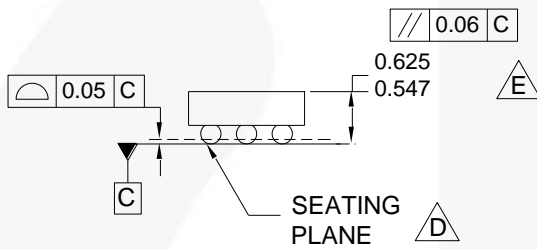
Physical Dimensions



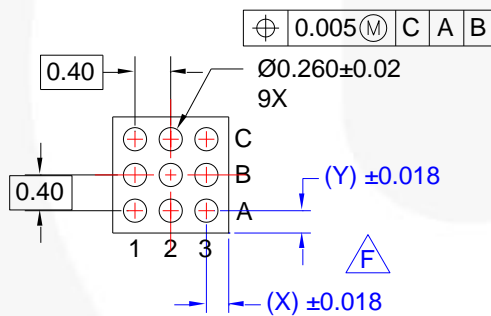
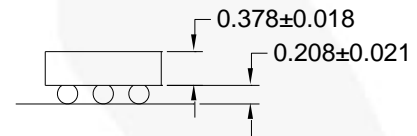
TOP VIEW



RECOMMENDED LAND PATTERN
(NSMD PAD TYPE)



SIDE VIEWS



BOTTOM VIEW

NOTES

- A. NO JEDEC REGISTRATION APPLIES.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCE PER ASME Y14.5M, 2009.
- D. DATUM C IS DEFINED BY THE SPHERICAL CROWNS OF THE BALLS.
- E. PACKAGE NOMINAL HEIGHT IS 586 ± 39 MICRONS (547-625 MICRONS).
- F. FOR DIMENSIONS D,E,X, AND Y SEE PRODUCT DATASHEET.
- G. DRAWING FILNAME: MKT-UC009Ak rev1

Figure 31. 9-Bump, 0.4 mm Pitch, WLCSP Package

Package drawings are provided as a service to customers considering Fairchild components. Drawings may change in any manner without notice. Please note the revision and/or date on the drawing and contact a Fairchild Semiconductor representative to verify or obtain the most recent revision. Package specifications do not expand the terms of Fairchild's worldwide terms and conditions, specifically the warranty therein, which covers Fairchild products.

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<http://www.fairchildsemi.com/dwg/UC/UC009AK.pdf>

For current packing container specifications, visit Fairchild Semiconductor's online packaging area:
http://www.fairchildsemi.com/packing_dwg/PKG-UC009AK.pdf

Product-Specific Dimensions

Product	D	E	X	Y
FAN48610UC50X	1.215 ±0.030 mm	1.215 ±0.030 mm	0.2075 mm	0.2075 mm
FAN48610BUC50X	1.215 ±0.030 mm	1.215 ±0.030 mm	0.2075 mm	0.2075 mm



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| | MicroPak™ | SPM® | UHC® |
| Fairchild® | MicroPak2™ | STEALTH™ | Ultra FRFET™ |
| Fairchild Semiconductor® | MillerDrive™ | SuperFET® | UniFET™ |
| FACT Quiet Series™ | MotionMax™ | SuperSOT™-3 | VCX™ |
| FACT® | mWSaver® | SuperSOT™-6 | VisualMax™ |
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Definition of Terms

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